## PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company  STMicroelectronics International N.V		STMicroelectronics International N.V
1.2 PCN No.		MDG/18/11130
1.3 Title of PCN		Extension of AMKOR XDLF SO8N assembly & test line usage to CMOSF8H Industrial Range EEPROM (M24256, M24512, M24M01, M24M02, M95256, M95512, M95M01, M95M02)
1.4 Product Category		EEPROM in SO8N from CMOS F8H process: M24256, M24512, M24M01, M24M02, M95256, M95512, M95M01, M95M02
1.5 Issue date		2018-10-09

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	ROBERTSON HEATHER	
2.1.2 Phone	+1 8475853058	
2.1.3 Email	heather.robertson@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Benoit RODRIGUES	
2.1.2 Marketing Manager	Hubert LEDUC	
2.1.3 Quality Manager	Rita PAVANO	

3. Change			
3.1 Category	3.2 Type of change	3.3 Manufacturing Location	
	New equipment changing process technique or using different technology (eg first equipment of a new brand)	AMKOR (Philippines)	

4. Description of change			
	Old	New	
4.1 Description	The EEPROM products (industrial range) processed with CMOSF8H process technology (M24256, M24512, M24M01, M24M02, M95256, M95512, M95M01, M95M02) at ST Rousset (France) and assembled/tested in SO8N package at ST Shenzhen (China) and at Amkor (Philippines) on HDLF line.	will be also assembled/tested on AMKOR extra high density lead frame (XDLF) assembly line.	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No change		

5. Reason / motivation for change		
5.1 Motivation	Capacity increase	
5.2 Customer Benefit	CAPACITY INCREASE	

6. Marking of parts / traceability of change		
6.1 Description	Finished Good Marking on Box Label	

7. Timing / schedule		
7.1 Date of qualification results	2018-11-16	
7.2 Intended start of delivery	2019-01-01	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation		
8.1 Description		

8.2 Qualification report and qualification results	In progress	Issue Date	
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## 9. Attachments (additional documentations)

11130 Public product.pdf 11130 XDLF\_P2v3.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	M24256-BRMN6TP	
	M24256-BWMN6TP	
	M24256-DFMN6TP	
	M24512-DFMN6TP	
	M24512-RMN6TP	
	M24512-WMN6TP	
	M24M01-DFMN6TP	
	M24M01-RMN6TP	
	M24M02-DRMN6TP	
	M95256-DFMN6TP	
	M95256-WMN6TP	
	M95512-DFMN6TP	
	M95512-RMN6TP	
	M95512-WMN6TP	
	M95M01-DFMN6TP	
	M95M01-RMN6TP	
	M95M02-DRMN6TP	



## **Public Products List**

Publict Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title: Extension of AMKOR XDLF SO8N assembly & test line usage

to CMOSF8H Industrial Range EEPROM (M24256, M24512, M24M01, M24M02, M95256, M95512, M95M01, M95M02)

PCN Reference: MDG/18/11130

Subject: Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

M24256-DFMN6TP	M24512-WMN6TP	M24256-BRMN6TP
M95256-WMN6TP	M95M02-DRMN6TP	M95256-DFMN6TP
M24M01-RMN6TP	M24512-DFMN6TP	M24M01-DFMN6TP
M24512-RMN6TP	M95512-DFMN6TP	M95256-RMN6TP
M95512-WMN6TP	M24256-BWMN6TP	M95M01-DFMN6TP
M24M02-DRMN6TP	M95512-RMN6TP	M95M01-RMN6TP

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